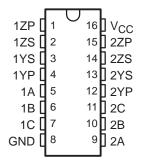
- Choice of Open-Collector, Open-Emitter, or Totem-Pole Outputs
- Single-Ended or Differential AND/NAND Outputs
- Single 5-V Supply
- Dual-Channel Operation
- TTL Compatible
- Short-Circuit Protection
- High-Current Outputs
- Triple inputs
- Clamp Diodes at Inputs and Outputs
- Designed for Use With SN55115 and SN75115 Differential Line Receivers
- Designed to Be Interchangeable With National DS9614 Line Driver

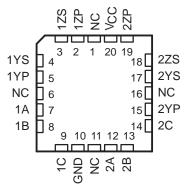
description

The SN55114 and SN75114 dual differential line drivers are designed to provide differential output signals with the high-current capability for driving balanced lines, such as twisted pair, at normal line impedances without high power dissipation. The output stages are similar to TTL totem-pole outputs, but with the sink outputs, YS and ZS, and the corresponding active pullup terminals, YP and ZP, available on adjacent package pins. Since the output stages provide TTL-compatible output levels, these devices can also be used as TTL expanders or phase splitters.

SN55114...J OR W PACKAGE SN75114...D OR N PACKAGE (TOP VIEW)



SN55114 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

The SN55114 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN75114 is characterized for operation from 0°C to 70°C.

FUNCTION TABLE

	INPUTS		OUTI	PUTS
Α	В	С	Υ	Z
Н	Н	Н	Н	L
All other	input comb	oinations	L	Н

H = high level, L = low level

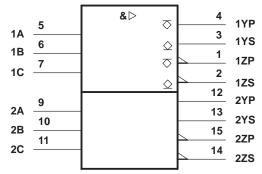


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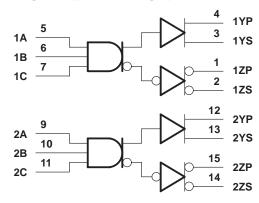
logic symbol†



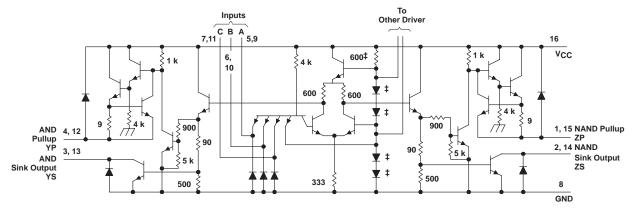
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the D, J, N, and W packages.

logic diagram (positive logic)



schematic (each driver)



[‡] These components are common to both drivers. Resistor values shown are nominal and in ohms. Pin numbers shown are for the D, J, N, and W packages.



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC} (see Note 1)	7 V
Input voltage, V _I	5.5 V
Off-state voltage applied to open-collector outputs	12 V
Continuous total power dissipation	See Dissipation Rating Table
Storage temperature range, T _{Stq}	65°C to 150°C
Case temperature for 60 seconds, T _c : FK package	260°C
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds: J or W package	
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: D or N package	ge 260°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values are with respect to the network ground terminal.

DISSIPATION RATING TABLE

PACKAGE	T _A ≤ 25°C POWER RATING	· · · · · · · · · · · · · · · · · · ·		T _A = 125°C POWER RATING
D	950 mW	7.6 mW/°C	608 mW	_
FK [‡]	1375 mW	11.0 mW/°C	880 mW	275 mW
J‡	1375 mW	11.0 mW/°C	880 mW	275 mW
N	1150 mW	9.2 mW/°C	736 mW	_
w‡	1000 mW	8.0 mW/°C	640 mW	200 mW

[‡] In the FK, J, and W packages, SN55114 chips are either silver glass or alloy mounted.

recommended operating conditions (unless otherwise noted)

	9	SN55114		SN75114			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	ONIT
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level input voltage, VIH	2			2			V
Low-level input voltage, V _{IL}			0.8			0.8	V
High-level output current, IOH			-40			-40	mA
Low-level output current, IOL			40			40	mA
Operating free-air temperature, T _A	-55		125	0		70	°C

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	_	TEST CONDITIONS [†]			SN55114	ļ.	;	ı	UNIT	
	PARAMETER	TEST CONDITIONS!			MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	Input clamp voltage	$V_{CC} = MIN,$	$I_{I} = -12 \text{ mA}$			-0.9	-1.5		-0.9	-1.5	V
VOH	High-level output	V _{CC} = MIN,	$V_{IH} = 2 V$	$I_{OH} = -10 \text{ mA}$	2.4	3.4		2.4	3.4		V
VOH	voltage	V _{IL} = 0.8 V		$I_{OH} = -40 \text{ mA}$	2	3		2	3		V
V _{OL}	Low-level output voltage	V _{CC} = MIN, V _{IL} = 0.8 V,	$V_{IH} = 2 V$, $I_{OL} = 40 \text{ mA}$			0.2	0.4		0.2	0.45	٧
Vou	Output alamp valtage	V _C C = 5 V,	I _O = 40 mA,	T _A = 25°C		6.1	6.5		6.1	6.5	V
VOK	Output clamp voltage	$V_{CC} = MAX$,	$I_{O} = -40 \text{ mA},$	T _A = 25°C		-1.1	-1.5		-1.1	-1.5	V
Off-state open collector	V _{CC} = MAX	V _{OH} = 12 V	T _A = 25°C		1	100				μΑ	
			T _A = 125°C			200					
^I O(off)	output current	ACC - MYX	V _{OH} = 5.25 V	T _A = 25°C					1	100	μΛ
			VOH = 3.23 V	T _A = 70°C						200	
tı	Input current at maximum input voltage	V _{CC} = MAX,	V _I = 5.5 V				1			1	mA
ΙΗ	High-level input current	$V_{CC} = MAX$,	V _I = 2.4 V				40			40	μΑ
I _I L	Low-level input current	$V_{CC} = MAX$,	V _I = 0.4 V			-1.1	-1.6		-1.1	-1.6	mA
los	Short-circuit output current§	V _{CC} = MAX,	V _O = 0,	T _A = 25°C	-40	-90	-120	-40	-90	-120	mA
loo	Supply current	All inputs at 0	V, No load,	$V_{CC} = MAX$		37	50		37	50	mA
Icc	(both drivers)	$T_A = 25^{\circ}C$		V _{CC} = 7 V		47	65		47	70	111/4

[†] All parameters, with the exception of off-state open-collector output current, are measured with the active pullup connected to the sink output. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

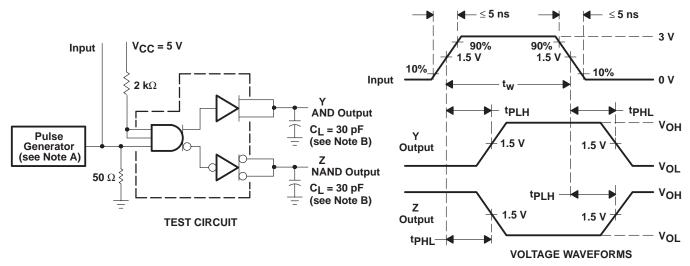
switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER		TEST	S	N55114		S	UNIT		
	PARAMETER	CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
tPLH	Propagation delay time, low- to high-level output	$C_L = 30 pF$,		15	20		15	30	ns
tPHL	Propagation delay time, high- to low-level output	See Figure 1		11	20		11	30	ns

 $^{^{\}ddagger}$ All typical values are at T_A = 25°C and V_{CC} = 5 V, with the exception of I_{CC} at 7 V.

[§] Only one output should be shorted at a time, and duration of the short circuit should not exceed one second.

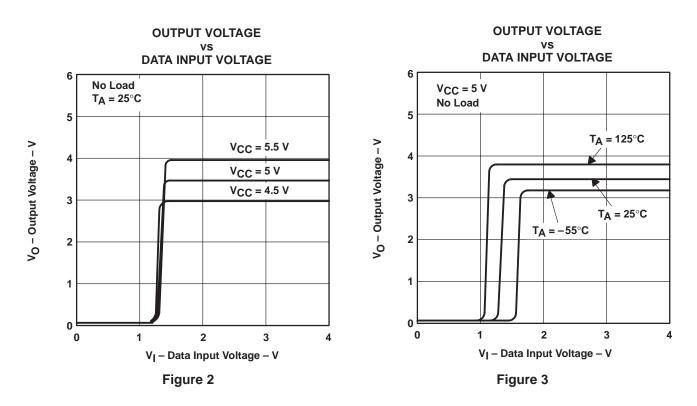
PARAMETER MEASUREMENT INFORMATION



- NOTES: A. The pulse generator has the following characteristics: $Z_0 = 500 \Omega$, PRR $\leq 500 \text{ kHz}$, $t_W \leq 100 \text{ ns}$.
 - B. C_I includes probe and jig capacitance.

Figure 1. Test Circuit and Voltage Waveforms

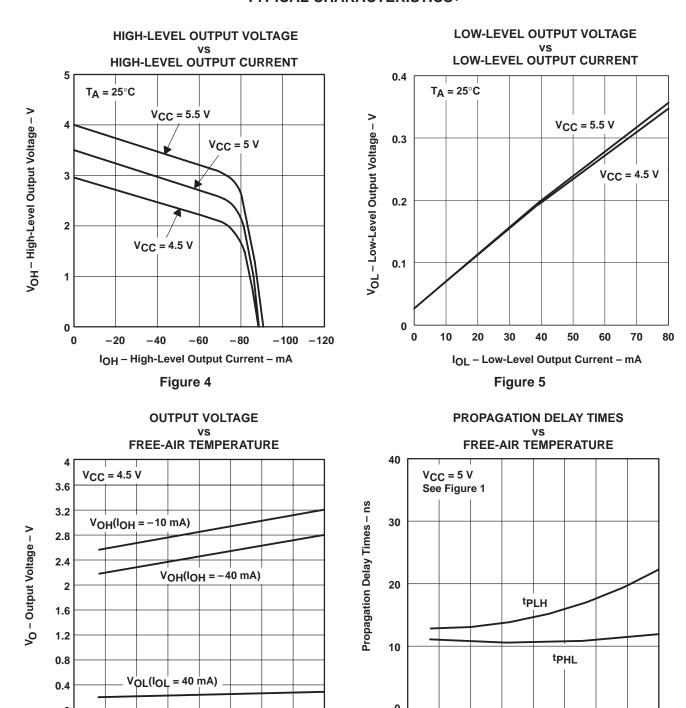
TYPICAL CHARACTERISTICS†



[†] Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. These parameters were measured with the active pullup connected to the sink output.



TYPICAL CHARACTERISTICS[†]



-75 -50

0

-25

50

75

100

125

25

 T_A – Free-Air Temperature – $^{\circ}$ C

Figure 7



-75 -50

-25

0

25

 T_A – Free-Air Temperature – $^{\circ}$ C

Figure 6

50

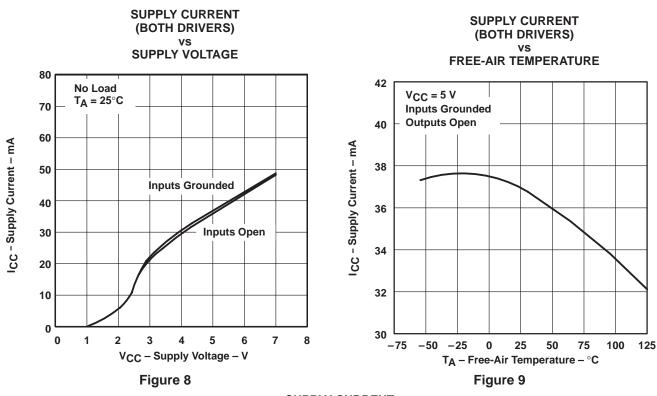
75

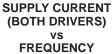
100

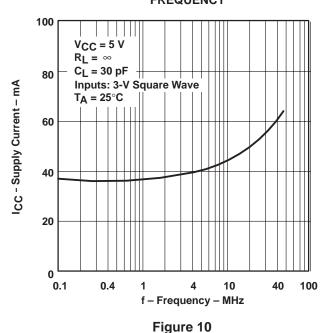
125

[†] Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. These parameters were measured with the active pullup connected to the sink output.

TYPICAL CHARACTERISTICS†



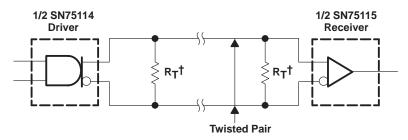




† Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. These parameters were measured with the active pullup connected to the sink output.



APPLICATION INFORMATION



 $^{^{\}dagger}$ R_T = Z_O. A capacitor can be connected in series with R_T to reduce power dissipation.

Figure 11. Basic Party-Line or Data-Bus Differential Data Transmission

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type	Package Pins	Package qty Carrier	(3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
5962-88744022A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 88744022A SNJ55 114FK
5962-8874402EA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8874402EA SNJ55114J
5962-8874402FA	Active	Production	CFP (W) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8874402FA SNJ55114W
JM38510/10403BEA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510 /10403BEA
JM38510/10403BEA.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510 /10403BEA
M38510/10403BEA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510 /10403BEA
SN55114J	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN55114J
SN55114J.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN55114J
SN75114D	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75114 9614CD
SN75114D.A	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75114 9614CD
SN75114DG4	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75114 9614CD
SN75114N	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN75114N
SN75114N.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN75114N
SNJ55114FK	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 88744022A SNJ55 114FK
SNJ55114FK.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 88744022A SNJ55 114FK
SNJ55114J	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8874402EA SNJ55114J

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Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking
	(1)	(2)			(5)	(4)	(5)		(0)
SNJ55114J.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8874402EA SNJ55114J
SNJ55114W	Active	Production	CFP (W) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8874402FA SNJ55114W
SNJ55114W.A	Active	Production	CFP (W) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8874402FA

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF SN55114, SN75114:

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE OPTION ADDENDUM

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● Catalog : SN75114

• Military : SN55114

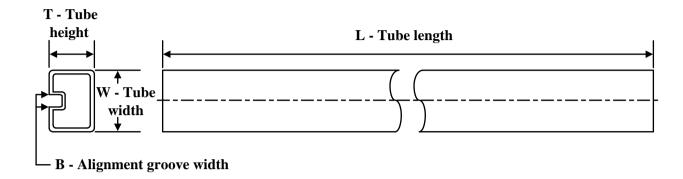
NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications



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TUBE

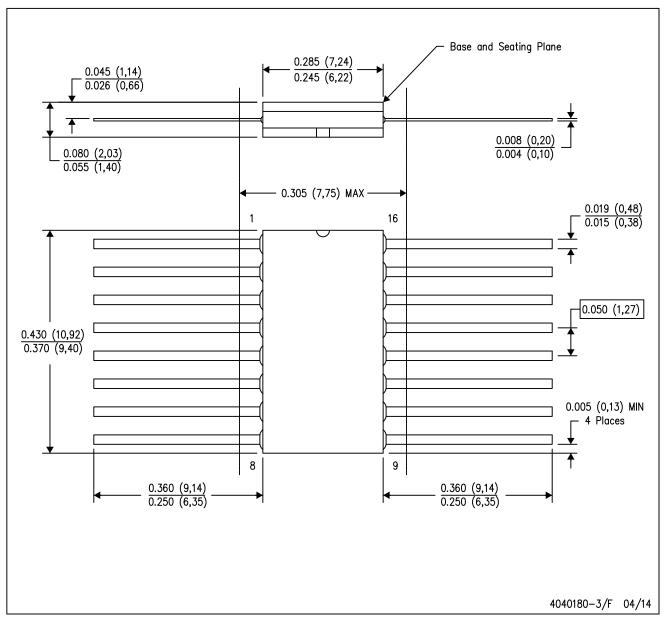


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
5962-88744022A	FK	LCCC	20	55	506.98	12.06	2030	NA
5962-8874402FA	W	CFP	16	25	506.98	26.16	6220	NA
SN75114D	D	SOIC	16	40	507	8	3940	4.32
SN75114D.A	D	SOIC	16	40	507	8	3940	4.32
SN75114DG4	D	SOIC	16	40	507	8	3940	4.32
SN75114N	N	PDIP	16	25	506	13.97	11230	4.32
SN75114N.A	N	PDIP	16	25	506	13.97	11230	4.32
SNJ55114FK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ55114FK.A	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ55114W	W	CFP	16	25	506.98	26.16	6220	NA
SNJ55114W.A	W	CFP	16	25	506.98	26.16	6220	NA

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



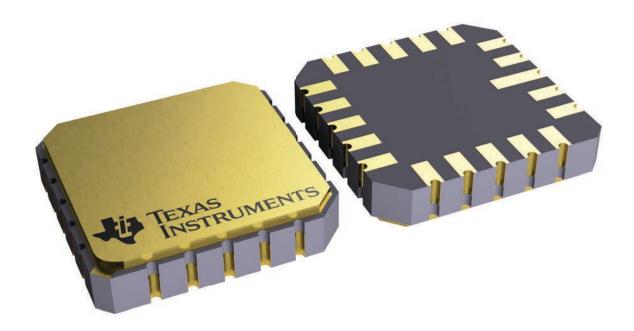
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP2-F16



8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



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14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



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